| ASBOCIATION CONNECTING<br>ELECTRONICS INDUSTRIES®<br>International and P | IPC, Bannock  | burn, Illinois. A         | ll rights reserved un<br>tions.             | nder both | This docume<br>level parts, t | ent is a declar<br>he declaratior                               | ation of n encon | f the substance<br>npasses all low | s within the<br>er level ma      | e manufactur<br>terials for w   | rer listed ite<br>hich the ma    | em. Note:<br>anufacture | if the item is an as<br>er has engineering | ssembly with low<br>responsibility. |
|--|---|---------------------------|---|-----------|-------------------------------|---|------------------|------------------------------------|----------------------------------|---------------------------------|----------------------------------|-------------------------|--|-------------------------------------|
|  | IPC Web Site for Information on IPC-1752 Standard Form Typ<br>http://www.ipc.org/IPC-175x Distributed |                           |   |           | e *                           | Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Mater |                  |                                    |                                  |                                 | ials and Mfg Information         |                         |  |                                     |
| upplier Information  |   |                           |   |           |                               |   |                  |                                    |                                  |                                 |                                  |                         |  |                                     |
| ompany name*   | Company uni   | Company unique ID         |   |           | Unique ID Authority           |   |                  |                                    |                                  | Response Date*                  |                                  |                         |  |                                     |
| ısemi  |   |                           |   |           |                               |   |                  |                                    |                                  |                                 | 2025-07-04                       |                         |  |                                     |
| Contact Name Title - Contact   |   |                           | et  | Pho       |                               |   | Phone - Contact* |                                    |                                  |                                 | Email - Contact*                 |                         |  |                                     |
| Product-Env-Stewards Produ   |   |                           | Product Enviro Compliance                   |           |                               | NA  |                  |                                    |                                  | Product-Env-Stewards@onsemi.com |                                  |                         |  |                                     |
| Authorized Representative* Title - Representat                           |   |                           | ntative Ph                                  |           |                               | Phone - Representative*   |                  |                                    |                                  | Email - Representative*         |                                  |                         |  |                                     |
| Product-Env-Stewards   |   | Product Enviro Compliance |   |           |                               | NA  |                  |                                    |                                  | Product-Env-Stewards@onsemi.com |                                  |                         |  |                                     |
| Requester Item Number  | Mfr Iter  | n Number                  | Mfr Item Name XGS45MP, 48port, Mono 10D CRA |           |                               | Effective Da  | ate Ve           | ersion                             | Manufacturing Site               |                                 | V                                | /eight*                 | UOM  | Unit Type                           |
|  | NOIX0   | SN045KB-GTI               |   |           | CRA                           | 2025-07-04 THA  |                  |                                    | 18407.2                          |                                 | mg                               | Each                    |  |                                     |
| Ianufacturing Proccess Inform  | ation   |                           |   |           |                               | 1   |                  |                                    |                                  |                                 |                                  |                         | 1  |                                     |
| Terminal Plating / Grid Array M  | Iaterial  | Terminal Base A           | lloy J-STD-020 MSL                          |           | L Rating                      | Peak Process Boo  |                  | Body Temperate                     | ody Temperature Max Time at Peal |                                 | Temperature Number of Reflow Cyc |                         | cles                                       |                                     |
| Precious metal (e.g. Ag,Au, NiPdAu) (no<br>Sn)                           |   | CU Alloy NA               |   | NA        |                               | 0   |                  | С                                  | 30                               |                                 | second                           | ls 3                    |  |                                     |
| omments  |   |                           |   |           |                               |   |                  |                                    |                                  |                                 |                                  |                         |  |                                     |
|  |   |                           |   |           |                               |   |                  |                                    |                                  |                                 |                                  |                         |  |                                     |
| or more information regarding materia                                    | l composition   | please refer to           | page 3                                      |           |                               |   |                  |                                    |                                  |                                 |                                  |                         |  |                                     |

| RoHS Material Composition Declaration  |   |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |
|--|---|--|---|---|---|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>y others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the  | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and co<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa   | on above   | Supplier Acceptance   | * Accepted                                      |   |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per  | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU  |  |   |   |   |  |  |  |  |  |  |
| Declaration Signature  |   |  |   |   |   |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester   | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska   | Le   |   |   |   |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | Weight  | Unit of Measure | Level    | Substance  | CAS         | Exempt | Weight    | Unit of Measure |
|----------------------|---------|-----------------|----------|--|-------------|--------|-----------|-----------------|
| Ceramic Substrate    | 13879.8 | mg              | Supplier | Cobalt (Co)                                      | 7440-48-4   |        | 1.388     | mg              |
|                      |         |                 | Supplier | Molybdenum (Mo)                                  | 7439-98-7   |        | 1.388     | mg              |
|                      |         |                 | Supplier | Tungsten (W)                                     | 7440-33-7   |        | 166.5576  | mg              |
|                      |         |                 | Supplier | Silica Amorphous (SiO2)                          | 7631-86-9   |        | 874.4274  | mg              |
|                      |         |                 | Supplier | Aluminum Trioxide (Al2O3)                        | 1344-28-1   |        | 12297.502 | mg              |
|                      |         |                 | В        | Nickel (Ni)                                      | 7440-02-0   |        | 38.8634   | mg              |
|                      |         |                 | Supplier | Gold (Au)  | 7440-57-5   |        | 27.7596   | mg              |
|                      |         |                 | Supplier | Chromium Trioxide (Cr2O3)                        | 1308-38-9   |        | 471.9132  | mg              |
| Die                  | 1011.6  | mg              | Supplier | Silicon (Si)                                     | 7440-21-3   |        | 1011.6    | mg              |
| Die Attach           | 147.4   | mg              | Supplier | Silver (Ag)                                      | 7440-22-4   |        | 125.29    | mg              |
|                      |         |                 | Supplier | Epoxy resins                                     | 129915-35-1 |        | 22.11     | mg              |
| Glass Attach Epoxy   | 83.5    | mg              | Supplier | 2,3-epoxypropyl-trimethoxysilan                  | 2530-83-8   |        | 7.181     | mg              |
|                      |         |                 | Supplier | N-[3-<br>(Trimethoxysilyl)propyl]ethylenediamine | 1760-24-3   |        | 5.7615    | mg              |
|                      |         |                 | Supplier | Bisphenol A_Epichlorohydrin Polymer              | 25068-38-6  |        | 34.736    | mg              |
|                      |         |                 | Supplier | 4,4'-Diaminodiphenyl Sulfone (DDS-4,4')          | 80-08-0     |        | 0.2505    | mg              |
|                      |         |                 | Supplier | Filler (SiO2?C2H6Cl2Si)                          | 68611-44-9  |        | 33.4      | mg              |
|                      |         |                 | Supplier | Carbon Black (C)                                 | 1333-86-4   |        | 2.171     | mg              |
| Glass Lid /Cap       | 3252.8  | mg              | Supplier | Boron Trioxide (B2O3)                            | 1303-86-2   |        | 273.2352  | mg              |
|                      |         |                 | Supplier | Silica Amorphous (SiO2)                          | 7631-86-9   |        | 1934.7655 | mg              |
|                      |         |                 | Supplier | Barium Monoxide (BaO)                            | 1304-28-5   |        | 266.7296  | mg              |
|                      |         |                 | Supplier | Aluminum Trioxide (Al2O3)                        | 1344-28-1   |        | 257.6218  | mg              |
|                      |         |                 | Supplier | Calcium Monoxide (CaO)                           | 1305-78-8   |        | 520.448   | mg              |
| Wire Bond - Au       | 32.1    | mg              | Supplier | Gold (Au)  | 7440-57-5   |        | 32.1      | mg              |